AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN

FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	5 A			
V _{RRM}	100 V			
I _{FSM}	100 A			
V_F at $I_F = 5$ A, $T_J = 125$ °C	0.59 V			
T _J max.	150 °C			
Package	SlimSMA (DO-221AC)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

J-51D-002 and JESD 22-D102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	VSSAF5103	UNIT
Device marking code		V513	
Maximum repetitive peak reverse voltage	V _{RRM}	100	V
Maximum DC forward current	I _{F(AV)} (1)	2.2	Δ.
	I _{F(AV)} (2)	5	- A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100	А
Operating junction temperature range	T _J (3)	-40 to +150	°C
Storage temperature range	T _{STG}	-55 to +150	°C

Notes

- (1) Free air, mounted on recommended copper pad area
- (2) Mounted on 30 mm x 30 mm pad area
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage per	I _F = 2.5 A	T _J = 25 °C	V _E (1)	0.53	-	V
	I _F = 5 A			0.64	0.71	
	I _F = 2.5 A	- T _J = 125 °C	'	0.49	-	
	I _F = 5 A			0.59	0.65	
Reverse current	V _R = 70 V	T _J = 25 °C T _J = 125 °C	I _R ⁽²⁾	0.004	ı	mA
		T _J = 125 °C		2.2	-	
	V _R = 100 V	T _J = 25 °C	I _R	-	0.21	- mA
		T _J = 125 °C		5	13	
Typical junction capacitance	4.0 V, 1 MHz		CJ	550	i	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 5 \text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	RAMETER SYMBOL VSSAF5103 U			
Typical thermal resistance	R ₀ JA (1)(2)	115	°C/W	
	R _{0JM} (3)	12	C/VV	

Notes

- $^{(3)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- (4) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/DT_J < 1/R_{\theta JA}$
- $^{(5)}$ Mounted on 30 mm x 30 mm pad area, $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF5103-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF5103-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
VSSAF5103HM3/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF5103HM3/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

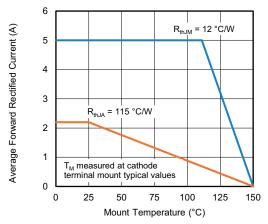


Fig. 1 - Maximum Forward Current Derating Curve

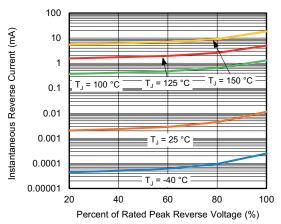


Fig. 4 - Typical Reverse Leakage Characteristics

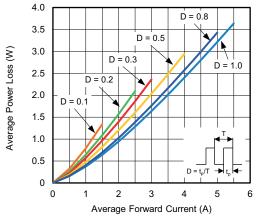


Fig. 2 - Forward Power Loss Characteristics

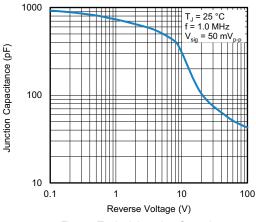
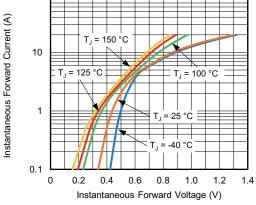


Fig. 5 - Typical Junction Capacitance



100

Fig. 3 - Typical Instantaneous Forward Characteristics

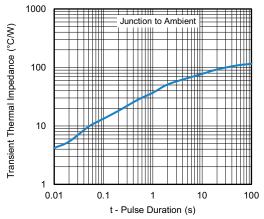


Fig. 6 - Typical Transient Thermal Impedance



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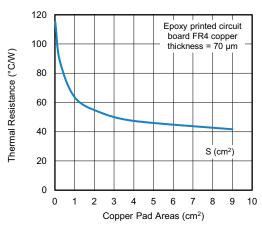
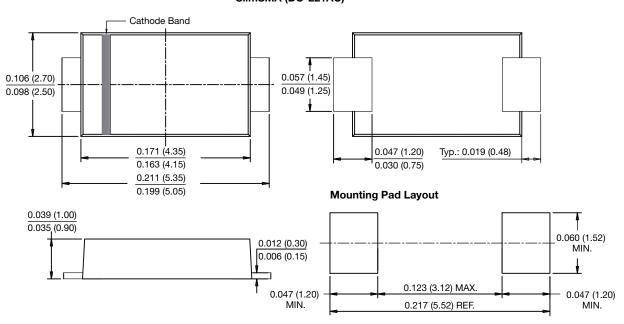


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC)





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